

## TS3A4751 0.9-Ω Low-voltage, single-supply, 4-channel spst analog switch

### 1 Features

- Low ON-State Resistance ( $R_{ON}$ )
  - 0.9 Ω Max (3-V Supply)
  - 1.5 Ω Max (1.8-V Supply)
- $R_{ON}$  Flatness: 0.4 Ω Max (3-V)
- $R_{ON}$  Channel Matching
  - 0.05 Ω Max (3-V Supply)
  - 0.15 Ω Max (1.8-V Supply)
- 1.6-V to 3.6-V Single-Supply Operation
- 1.8-V CMOS Logic Compatible (3-V Supply)
- High Current-Handling Capacity (100 mA Continuous)
- Fast Switching:  $t_{ON} = 5$  ns,  $t_{OFF} = 4$  ns
- Supports Both Digital and Analog Applications
- ESD Protection Exceeds JESD-22
  - ±4000-V Human Body Model (A114-A)
  - 300-V Machine Model (A115-A)
  - ±1000-V Charged-Device Model (C101)

### 2 Applications

- Power Routing
- Battery-Powered Systems
- Audio and Video Signal Routing
- Low-Voltage Data-Acquisition Systems
- Communications Circuits
- PCMCIA Cards
- Cellular Phones
- Modems
- Hard Drives

### 3 Description

The TS3A4751 device is a bidirectional, 4-channel, normally open (NO) single-pole single-throw (SPST) analog switch that operates from a single 1.6-V to 3.6-V supply. This device has fast switching speeds, handles rail-to-rail analog signals, and consumes very low quiescent power.

The digital input is 1.8-V CMOS compatible when using a 3-V supply.

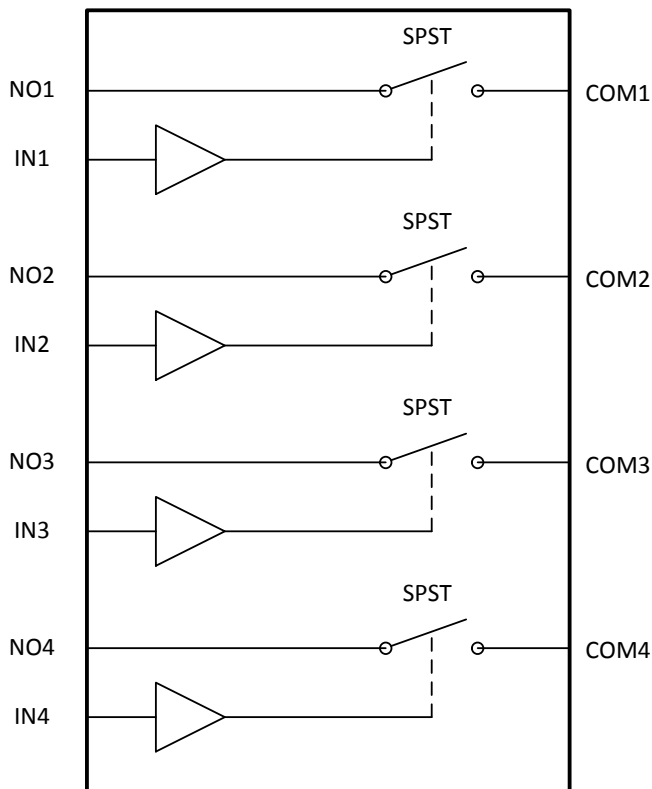
The TS3A4751 device has four normally open (NO) switches. The TS3A4751 is available in a 14-pin thin shrink small-outline package (TSSOP) and in space-saving 14-pin VQFN (RGY) and micro X2QFN (RUC) packages.

Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE    | BODY SIZE (NOM)   |
|-------------|------------|-------------------|
| TS3A4751    | TSSOP (14) | 5.00 mm × 4.40 mm |
|             | VQFN (14)  | 3.50 mm × 3.50 mm |
|             | X2QFN (14) | 2.00 mm × 2.00 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Simplified Schematic



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## 4 Revision History

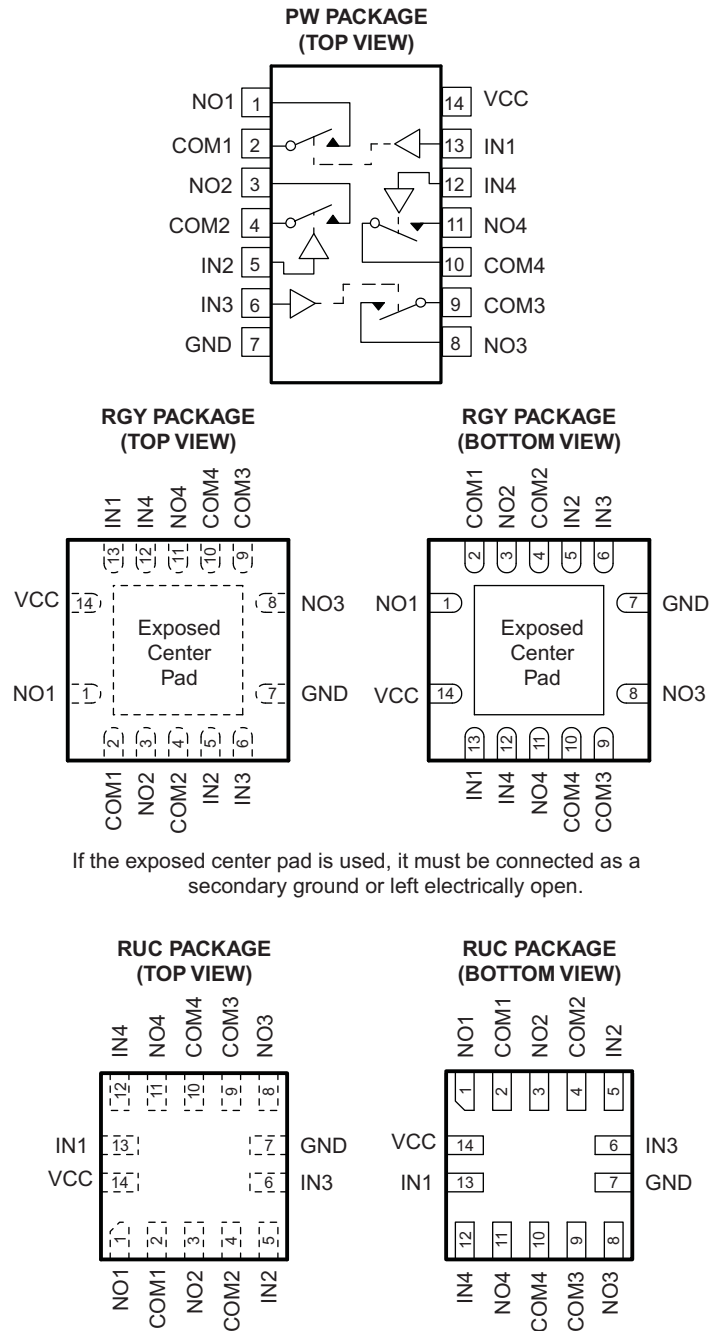
### Changes from Revision E (January 2015) to Revision F Page

- Changed Supply Voltage from: 3.3 V to: 3.6 V in the *Recommended Operating Conditions* ..... **5**

### Changes from Revision D (July 2008) to Revision E Page

- Added *Pin Configuration and Functions* section, *ESD Ratings* table, *Feature Description* section, *Device Functional Modes*, *Application and Implementation* section, *Power Supply Recommendations* section, *Layout* section, *Device and Documentation Support* section, and *Mechanical, Packaging, and Orderable Information* section ..... **1**

## 5 Pin Configuration and Functions



## Pin Functions

| PIN |                 | I/O | DESCRIPTION               |
|-----|-----------------|-----|---------------------------|
| NO. | NAME            |     |                           |
| 1   | NO1             | I/O | Normally open signal path |
| 2   | COM1            | I/O | Common signal path        |
| 3   | NO2             | I/O | Normally open signal path |
| 4   | COM2            | I/O | Common signal path        |
| 5   | IN2             | I   | Logic control input       |
| 6   | IN3             | I   | Logic control input       |
| 7   | GND             | —   | Ground                    |
| 8   | NO3             | I/O | Normally open signal path |
| 9   | COM3            | I/O | Common signal path        |
| 10  | COM4            | I/O | Common signal path        |
| 11  | NO4             | I/O | Normally open signal path |
| 12  | IN4             | I   | Logic control input       |
| 13  | IN1             | I   | Logic control input       |
| 14  | V <sub>CC</sub> | I   | Positive supply voltage   |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                        |                                                   |                                                           | MIN  | MAX                   | UNIT |
|--------------------------------------------------------|---------------------------------------------------|-----------------------------------------------------------|------|-----------------------|------|
| V <sub>CC</sub>                                        | Supply voltage referenced to GND <sup>(2)</sup>   |                                                           | −0.3 | 4                     | V    |
| V <sub>NO</sub><br>V <sub>COM</sub><br>V <sub>IN</sub> | Analog and digital voltage                        |                                                           | −0.3 | V <sub>CC</sub> + 0.3 | V    |
| I <sub>NO</sub><br>I <sub>COM</sub>                    | On-state switch current                           | V <sub>NO</sub> , V <sub>COM</sub> = 0 to V <sub>CC</sub> | −100 | 100                   | mA   |
| I <sub>CC</sub><br>I <sub>GND</sub>                    | Continuous current through V <sub>CC</sub> or GND |                                                           |      | ±100                  | mA   |
| V                                                      | Peak current pulsed at 1 ms, 10% duty cycle       | COM, V <sub>I/O</sub>                                     |      | ±200                  | mA   |
| T <sub>A</sub>                                         | Operating temperature                             |                                                           | −40  | 85                    | °C   |
| T <sub>J</sub>                                         | Junction temperature                              |                                                           |      | 150                   | °C   |
| T <sub>std</sub>                                       | Storage temperature                               |                                                           | −65  | 150                   | °C   |

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under [Recommended Operating Conditions](#) is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Signals on COM or NO exceeding V<sub>CC</sub> or GND are clamped by internal diodes. Limit forward diode current to maximum current rating.

### 6.2 ESD Ratings

|                    |                         | VALUE                                                                                                    | UNIT  |
|--------------------|-------------------------|----------------------------------------------------------------------------------------------------------|-------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>                                        | ±4000 |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 or ANSI/ESDA/JEDEC JS-002 <sup>(2)</sup> | ±1000 |
|                    |                         | Machine Model                                                                                            | ±300  |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                                                        |                                  | MIN  | MAX             | UNIT |
|--------------------------------------------------------|----------------------------------|------|-----------------|------|
| V <sub>CC</sub>                                        | Supply Voltage                   | 1.65 | 3.6             | V    |
| V <sub>NO</sub><br>V <sub>COM</sub><br>V <sub>IN</sub> | Analog and digital voltage range | 0    | V <sub>CC</sub> | V    |

### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TS3A4751 |      |       | UNIT |
|-------------------------------|----------------------------------------------|----------|------|-------|------|
|                               |                                              | PW       | RGY  | RUC   |      |
|                               |                                              |          |      |       |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 132.3    | 68.5 | 196.4 | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 60.6     | 83.1 | 73.9  |      |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 74.2     | 44.6 | 130.7 |      |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 11.2     | 7.8  | 2.1   |      |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 73.6     | 44.7 | 130.6 |      |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | N/A      | 24.6 | N/A   |      |

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## 6.5 Electrical Characteristics for 1.8-V Supply

 $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ ,  $T_A = -40^\circ\text{C to }85^\circ\text{C}$ ,  $V_{IH} = 1\text{ V}$ ,  $V_{IL} = 0.4\text{ V}$  (unless otherwise noted)<sup>(1) (2)</sup>

| PARAMETER                          | TEST CONDITIONS                                           |                                                                                                            | T <sub>A</sub> | MIN    | TYP <sup>(3)</sup> | MAX             | UNIT |
|------------------------------------|-----------------------------------------------------------|------------------------------------------------------------------------------------------------------------|----------------|--------|--------------------|-----------------|------|
| ANALOG SWITCH                      |                                                           |                                                                                                            |                |        |                    |                 |      |
| V <sub>COM</sub> , V <sub>NO</sub> | Analog signal range                                       |                                                                                                            |                | 0      |                    | V <sub>CC</sub> | V    |
| R <sub>on</sub>                    | ON-state resistance                                       | V <sub>CC</sub> = 1.8 V, I <sub>COM</sub> = −10 mA, V <sub>NO</sub> = 0.9 V                                | 25°C           | 1      | 1.5                |                 | Ω    |
|                                    |                                                           |                                                                                                            | Full           |        | 2                  |                 |      |
| ΔR <sub>on</sub>                   | ON-state resistance match between channels <sup>(4)</sup> | V <sub>CC</sub> = 1.8 V, I <sub>COM</sub> = −10 mA, V <sub>NO</sub> = 0.9 V                                | 25°C           | 0.09   | 0.15               |                 | Ω    |
|                                    |                                                           |                                                                                                            | Full           |        | 0.25               |                 |      |
| R <sub>on(flat)</sub>              | ON-state resistance flatness <sup>(5)</sup>               | V <sub>CC</sub> = 1.8 V, I <sub>COM</sub> = −10 mA, 0 ≤ V <sub>NO</sub> ≤ V <sub>CC</sub>                  | 25°C           | 0.7    | 0.9                |                 | Ω    |
|                                    |                                                           |                                                                                                            | Full           |        | 1.5                |                 |      |
| I <sub>NO(OFF)</sub>               | NO OFF leakage current <sup>(6)</sup>                     | V <sub>CC</sub> = 1.95 V, V <sub>COM</sub> = 0.15 V, 1.65 V, V <sub>NO</sub> = 1.8 V, 0.15 V               | 25°C           | −1     | 0.5                | 1               | nA   |
|                                    |                                                           |                                                                                                            | Full           | −10    |                    | 10              |      |
| I <sub>COM(OFF)</sub>              | COM OFF leakage current <sup>(6)</sup>                    | V <sub>CC</sub> = 1.95 V, V <sub>COM</sub> = 0.15 V, 1.65 V, V <sub>NO</sub> = 1.65 V, 0.15 V              | 25°C           | −1     | 0.5                | 1               | nA   |
|                                    |                                                           |                                                                                                            | Full           | −10    |                    | 10              |      |
| I <sub>COM(ON)</sub>               | COM ON leakage current <sup>(6)</sup>                     | V <sub>CC</sub> = 1.95 V, V <sub>COM</sub> = 0.15 V, 1.65 V, V <sub>NO</sub> = 0.15 V, 1.65 V, or floating | 25°C           | −1     | 0.01               | 1               | nA   |
|                                    |                                                           |                                                                                                            | Full           | −3     |                    | 3               |      |
| DYNAMIC                            |                                                           |                                                                                                            |                |        |                    |                 |      |
| t <sub>ON</sub>                    | Turn-on time                                              | V <sub>NO</sub> = 1.5 V, R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 35 pF, See <a href="#">Figure 1</a>       | 25°C           | 6      | 18                 |                 | ns   |
|                                    |                                                           |                                                                                                            | Full           |        | 20                 |                 |      |
| t <sub>OFF</sub>                   | Turn-off time                                             | V <sub>NO</sub> = 1.5 V, R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 35 pF, See <a href="#">Figure 1</a>       | 25°C           | 5      | 10                 |                 | ns   |
|                                    |                                                           |                                                                                                            | Full           |        | 12                 |                 |      |
| Q <sub>C</sub>                     | Charge injection                                          | V <sub>GEN</sub> = 0, R <sub>GEN</sub> = 0, C <sub>L</sub> = 1 nF, See <a href="#">Figure 5</a>            | 25°C           | 3.2    |                    |                 | pC   |
| C <sub>NO(OFF)</sub>               | NO OFF capacitance                                        | f = 1 MHz, See <a href="#">Figure 2</a>                                                                    | 25°C           | 23     |                    |                 | pF   |
| C <sub>COM(OFF)</sub>              | COM OFF capacitance                                       | f = 1 MHz, See <a href="#">Figure 2</a>                                                                    | 25°C           | 20     |                    |                 | pF   |
| C <sub>COM(ON)</sub>               | COM ON capacitance                                        | f = 1 MHz, See <a href="#">Figure 2</a>                                                                    | 25°C           | 43     |                    |                 | pF   |
| BW                                 | Bandwidth                                                 | R <sub>L</sub> = 50 Ω, Switch ON                                                                           | 25°C           | 123    |                    |                 | MHz  |
| O <sub>ISO</sub>                   | OFF isolation <sup>(7)</sup>                              | R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5 pF, See <a href="#">Figure 3</a>                                 | 25°C           | −61    |                    |                 | dB   |
|                                    |                                                           | f = 10 MHz                                                                                                 |                | −36    |                    |                 |      |
| X <sub>TALK</sub>                  | Crosstalk                                                 | R <sub>L</sub> = 50 Ω, C <sub>L</sub> = 5 pF, See <a href="#">Figure 3</a>                                 | 25°C           | −95    |                    |                 | dB   |
|                                    |                                                           | f = 100 MHz                                                                                                |                | −73    |                    |                 |      |
| THD                                | Total harmonic distortion                                 | f = 20 Hz to 20 kHz, V <sub>COM</sub> = 2 V <sub>P-P</sub>                                                 | 25°C           | 0.14%  |                    |                 |      |
|                                    |                                                           | R <sub>L</sub> = 600 Ω                                                                                     |                | 0.013% |                    |                 |      |
| DIGITAL CONTROL INPUTS (IN1–IN4)   |                                                           |                                                                                                            |                |        |                    |                 |      |
| V <sub>IH</sub>                    | Input logic high                                          |                                                                                                            | Full           | 1      |                    |                 | V    |
| V <sub>IL</sub>                    | Input logic low                                           |                                                                                                            | Full           |        | 0.4                |                 | V    |
| I <sub>IN</sub>                    | Input leakage current                                     | V <sub>I</sub> = 0 or V <sub>CC</sub>                                                                      | 25°C           | 0.1    | 5                  |                 | nA   |
|                                    |                                                           |                                                                                                            | Full           | −10    | 10                 |                 |      |
| SUPPLY                             |                                                           |                                                                                                            |                |        |                    |                 |      |
| V <sub>CC</sub>                    | Power-supply range                                        |                                                                                                            |                | 1.6    | 3.6                |                 | V    |
| I <sub>CC</sub>                    | Positive-supply current                                   | V <sub>I</sub> = 0 or V <sub>CC</sub>                                                                      | 25°C           |        | 0.05               |                 | μA   |
|                                    |                                                           |                                                                                                            | Full           |        | 0.5                |                 |      |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

(2) Parts are tested at  $85^\circ\text{C}$  and specified by design and correlation over the full temperature range.

(3) Typical values are at  $T_A = 25^\circ\text{C}$ .

(4)  $\Delta r_{on} = r_{on(max)} - r_{on(min)}$

(5) Flatness is defined as the difference between the maximum and minimum value of  $r_{on}$  as measured over the specified analog signal ranges.

(6) Leakage parameters are 100% tested at the maximum-rated hot operating temperature and specified by correlation at  $T_A = 25^\circ\text{C}$ .

(7) OFF isolation =  $20_{\log}10 (V_{COM}/V_{NO})$ ,  $V_{COM}$  = output,  $V_{NO}$  = input to OFF switch

## 6.6 Electrical Characteristics for 3-V Supply

 $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ ,  $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ ,  $V_{IH} = 1.4 \text{ V}$ ,  $V_{IL} = 0.5 \text{ V}$  (unless otherwise noted).<sup>(1) (2)</sup>

| PARAMETER                               |                                                           | TEST CONDITIONS                                                                                                            | $T_A$                                   | MIN  | TYP <sup>(3)</sup> | MAX      | UNIT          |
|-----------------------------------------|-----------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------|-----------------------------------------|------|--------------------|----------|---------------|
| <b>ANALOG SWITCH</b>                    |                                                           |                                                                                                                            |                                         |      |                    |          |               |
| $V_{COM}$ , $V_{NO}$                    | Analog signal range                                       |                                                                                                                            |                                         | 0    |                    | $V_{CC}$ | V             |
| $R_{on}$                                | ON-state resistance                                       | $V_{CC} = 2.7 \text{ V}$ , $I_{COM} = -100 \text{ mA}$ ,<br>$V_{NO} = 1.5 \text{ V}$                                       | 25°C                                    | 0.7  | 0.9                |          | $\Omega$      |
|                                         |                                                           |                                                                                                                            | Full                                    |      | 1.1                |          |               |
| $\Delta R_{on}$                         | ON-state resistance match between channels <sup>(4)</sup> | $V_{CC} = 2.7 \text{ V}$ , $I_{COM} = -100 \text{ mA}$ ,<br>$V_{NO} = 1.5 \text{ V}$                                       | 25°C                                    | 0.03 | 0.05               |          | $\Omega$      |
|                                         |                                                           |                                                                                                                            | Full                                    |      | 0.15               |          |               |
| $R_{on(Flat)}$                          | ON-state resistance flatness <sup>(5)</sup>               | $V_{CC} = 2.7 \text{ V}$ , $I_{COM} = -100 \text{ mA}$ ,<br>$V_{NO} = 1 \text{ V}, 1.5 \text{ V}, 2 \text{ V}$             | 25°C                                    | 0.23 | 0.4                |          | $\Omega$      |
|                                         |                                                           |                                                                                                                            | Full                                    |      | 0.5                |          |               |
| $I_{NO(OFF)}$                           | NO OFF leakage current <sup>(6)</sup>                     | $V_{CC} = 3.6 \text{ V}$ , $V_{COM} = 0.3 \text{ V}, 3 \text{ V}$ ,<br>$V_{NO} = 3 \text{ V}, 0.3 \text{ V}$               | 25°C                                    | -2   | 1                  | 2        | nA            |
|                                         |                                                           |                                                                                                                            | Full                                    | -18  |                    | 18       |               |
| $I_{COM(OFF)}$                          | COM OFF leakage current <sup>(6)</sup>                    | $V_{CC} = 3.6 \text{ V}$ , $V_{COM} = 0.3 \text{ V}, 3 \text{ V}$ ,<br>$V_{NO} = 3 \text{ V}, 0.3 \text{ V}$               | 25°C                                    | -2   | 1                  | 2        | nA            |
|                                         |                                                           |                                                                                                                            | Full                                    | -18  |                    | 18       |               |
| $I_{COM(ON)}$                           | COM ON leakage current <sup>(6)</sup>                     | $V_{CC} = 3.6 \text{ V}$ , $V_{COM} = 0.3 \text{ V}, 3 \text{ V}$ ,<br>$V_{NO} = 0.3 \text{ V}, 3 \text{ V}$ , or floating | 25°C                                    | -2.5 | 0.01               | 2.5      | nA            |
|                                         |                                                           |                                                                                                                            | Full                                    | -5   |                    | 5        |               |
| <b>DYNAMIC</b>                          |                                                           |                                                                                                                            |                                         |      |                    |          |               |
| $t_{ON}$                                | Turn-on time                                              | $V_{NO} = 1.5 \text{ V}$ , $R_L = 50 \Omega$ ,<br>$C_L = 35 \text{ pF}$ , See Figure 1                                     | 25°C                                    | 5    | 14                 |          | ns            |
|                                         |                                                           |                                                                                                                            | Full                                    |      | 15                 |          |               |
| $t_{OFF}$                               | Turn-off time                                             | $V_{NO} = 1.5 \text{ V}$ , $R_L = 50 \Omega$ ,<br>$C_L = 35 \text{ pF}$ , See Figure 1                                     | 25°C                                    | 4    | 9                  |          | ns            |
|                                         |                                                           |                                                                                                                            | Full                                    |      | 10                 |          |               |
| $Q_C$                                   | Charge injection                                          | $V_{GEN} = 0$ , $R_{GEN} = 0$ , $C_L = 1 \text{ nF}$ ,<br>See Figure 5                                                     | 25°C                                    | 3    |                    |          | pC            |
| $C_{NO(OFF)}$                           | NO OFF capacitance                                        | $f = 1 \text{ MHz}$ , See Figure 2                                                                                         | 25°C                                    | 23   |                    |          | pF            |
| $C_{COM(OFF)}$                          | COM OFF capacitance                                       | $f = 1 \text{ MHz}$ , See Figure 2                                                                                         | 25°C                                    | 20   |                    |          | pF            |
| $C_{COM(ON)}$                           | COM ON capacitance                                        | $f = 1 \text{ MHz}$ , See Figure 2                                                                                         | 25°C                                    | 43   |                    |          | pF            |
| BW                                      | Bandwidth                                                 | $R_L = 50 \Omega$ , Switch ON                                                                                              | 25°C                                    | 125  |                    |          | MHz           |
| $O_{ISO}$                               | OFF isolation <sup>(7)</sup>                              | $R_L = 50 \Omega$ , $C_L = 5 \text{ pF}$ ,<br>See Figure 3                                                                 | f = 10 MHz<br>f = 1 MHz                 | 25°C | -40<br>-62         |          | dB            |
| $X_{TALK}$                              | Crosstalk                                                 | $R_L = 50 \Omega$ , $C_L = 5 \text{ pF}$ ,<br>See Figure 3                                                                 | f = 10 MHz<br>f = 1 MHz                 | 25°C | -73<br>-95         |          | dB            |
| THD                                     | Total harmonic distortion                                 | f = 20 Hz to 20 kHz,<br>$V_{COM} = 2 V_{P-P}$                                                                              | $R_L = 32 \Omega$<br>$R_L = 600 \Omega$ | 25°C | 0.04%<br>0.003%    |          |               |
| <b>DIGITAL CONTROL INPUTS (IN1-IN4)</b> |                                                           |                                                                                                                            |                                         |      |                    |          |               |
| $V_{IH}$                                | Input logic high                                          |                                                                                                                            | Full                                    | 1.4  |                    |          | V             |
| $V_{IL}$                                | Input logic low                                           |                                                                                                                            | Full                                    |      | 0.5                |          | V             |
| $I_{IN}$                                | Input leakage current                                     | $V_I = 0 \text{ or } V_{CC}$                                                                                               | 25°C                                    | 0.5  | 1                  |          | nA            |
|                                         |                                                           |                                                                                                                            | Full                                    | -20  | 20                 |          |               |
| <b>SUPPLY</b>                           |                                                           |                                                                                                                            |                                         |      |                    |          |               |
| $V_{CC}$                                | Power-supply range                                        |                                                                                                                            |                                         | 1.6  | 3.6                |          | V             |
| $I_{CC}$                                | Positive-supply current                                   | $V_{CC} = 3.6 \text{ V}$ , $V_{IN} = 0 \text{ or } V_{CC}$                                                                 | 25°C                                    |      | 0.075              |          | $\mu\text{A}$ |
|                                         |                                                           |                                                                                                                            | Full                                    |      | 0.75               |          |               |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

(2) Parts are tested at 85°C and specified by design and correlation over the full temperature range.

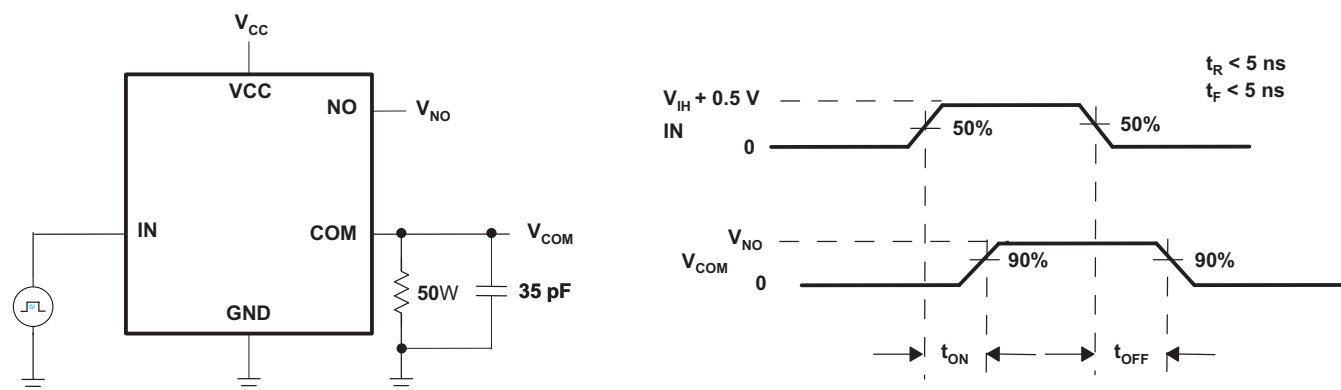
(3) Typical values are at  $V_{CC} = 3 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

(4)  $\Delta r_{on} = r_{on(max)} - r_{on(min)}$

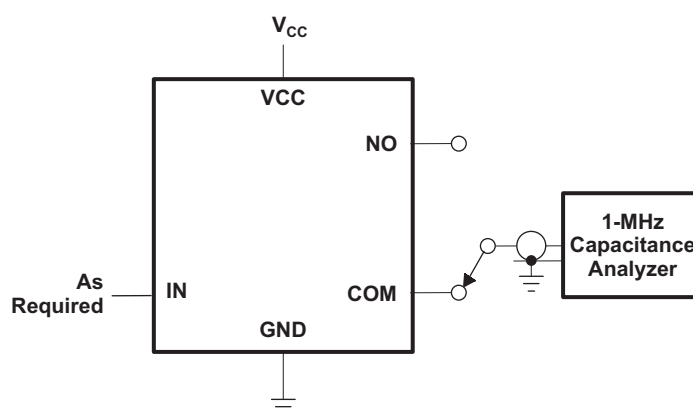
(5) Flatness is defined as the difference between the maximum and minimum value of  $r_{on}$  as measured over the specified analog signal ranges.

(6) Leakage parameters are 100% tested at the maximum-rated hot operating temperature and specified by correlation at  $T_A = 25^\circ\text{C}$ .

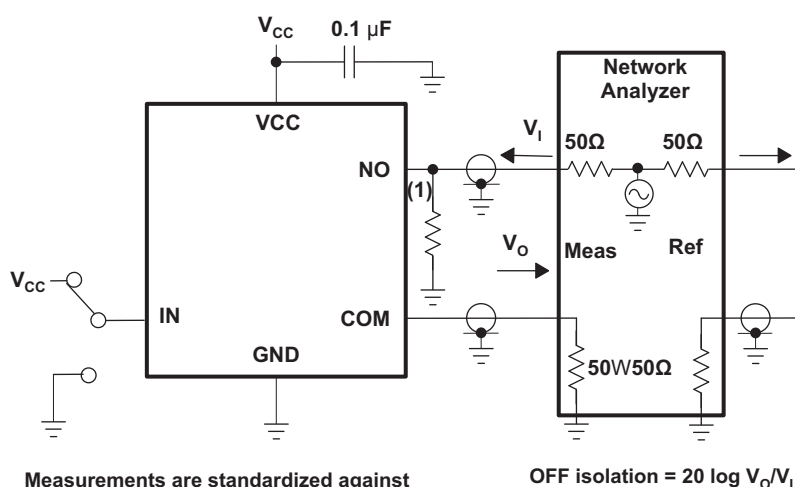
(7) OFF isolation =  $20_{\log 10} (V_{COM}/V_{NO})$ ,  $V_{COM}$  = output,  $V_{NO}$  = input to OFF switch



**Figure 1. Switching Times**



**Figure 2. NO and COM Capacitance**



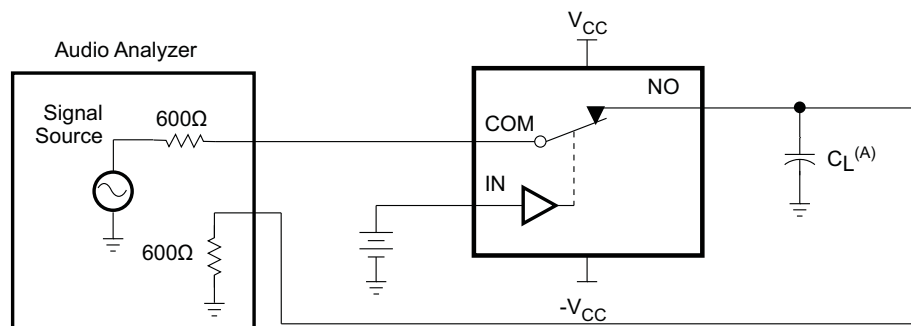
Measurements are standardized against short at socket terminals. OFF isolation is measured between COM and OFF terminals on each switch. Bandwidth is measured between COM and ON terminals on each switch. Signal direction through switch is reversed; worst values are recorded.

$$\text{OFF isolation} = 20 \log V_O/V_I$$

(1) Add 50-Ω termination for OFF isolation

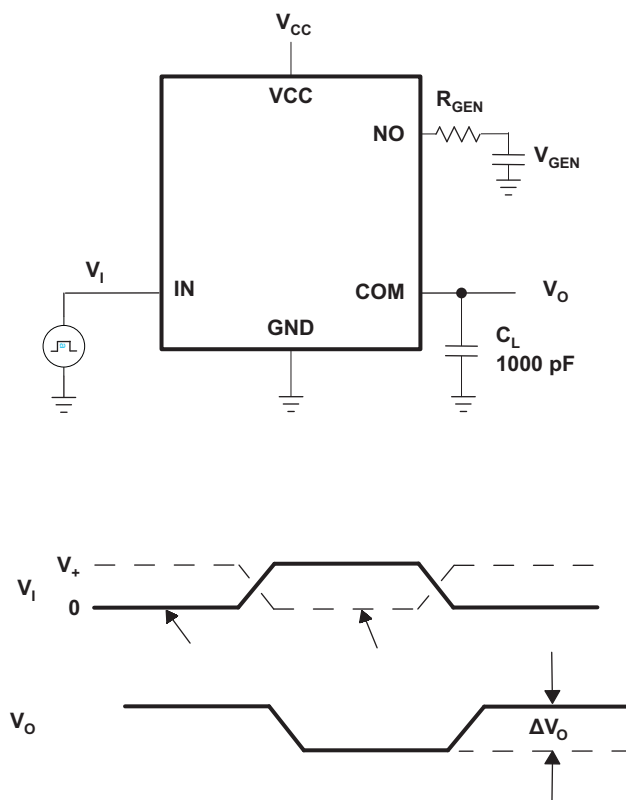
**Figure 3. OFF Isolation, Bandwidth, and Crosstalk**

Channel ON: COM to NO     $V_I = V_{CC}$      $C_L = 50 \text{ pF}$   
 $V_{SOURCE} = V_{CC} \text{ P-P}$      $f_{SOURCE} = 20 \text{ Hz to } 20 \text{ kHz}$      $R_L = 600\Omega$



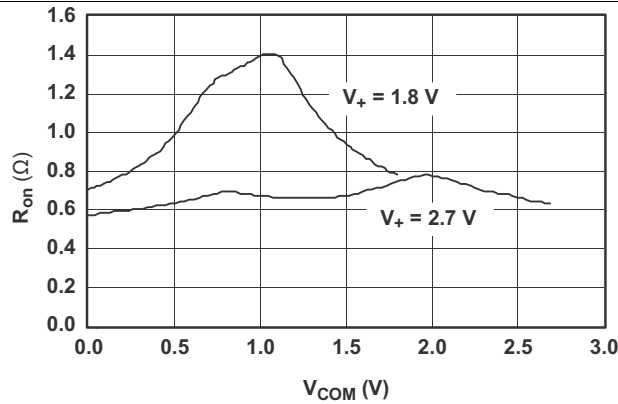
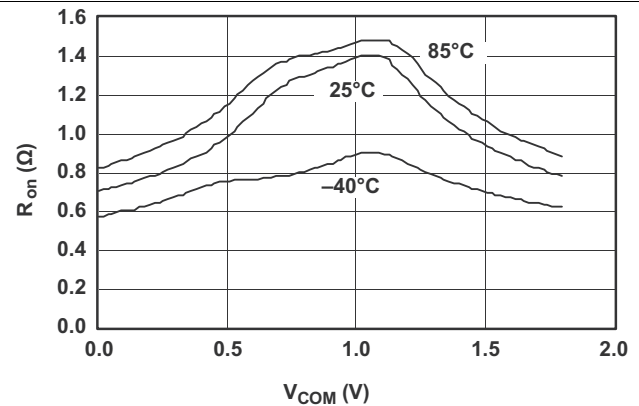
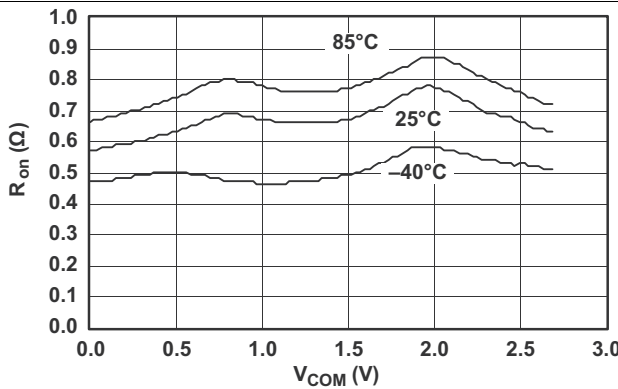
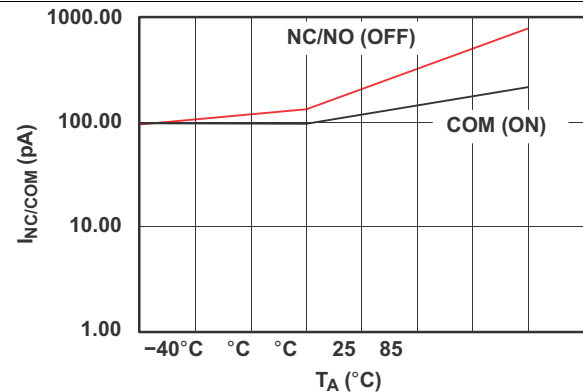
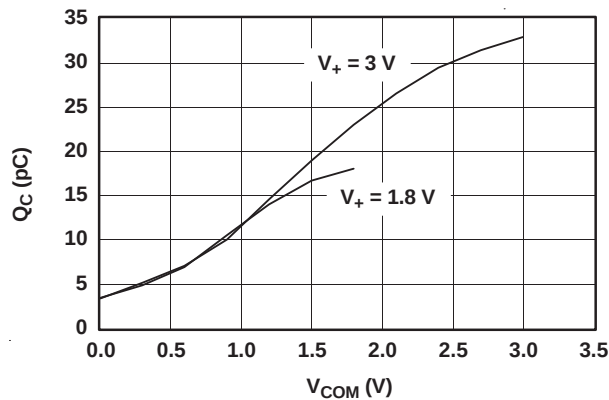
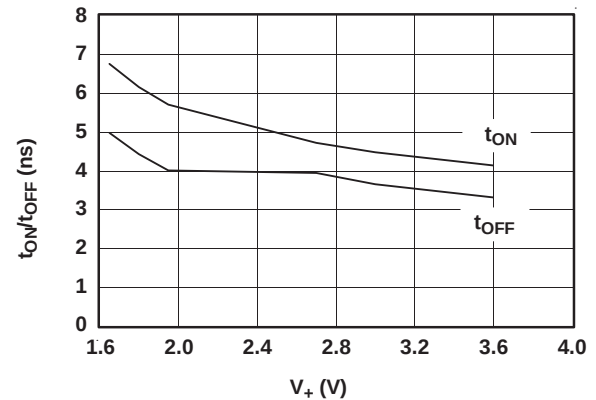
A.  $C_L$  includes probe and jig capacitance.

**Figure 4. Total Harmonic Distortion (THD)**



**Figure 5. Charge Injection ( $Q_C$ )**

## 6.7 Typical Characteristics


Figure 6.  $R_{on}$  vs  $V_{COM}$ 

Figure 7.  $R_{on}$  vs  $V_{COM}$  ( $V_{CC} = 1.8$  V)

Figure 8.  $R_{on}$  vs  $V_{COM}$  ( $V_{CC} = 2.7$  V)

Figure 9.  $I_{ON}$  and  $I_{OFF}$  vs Temperature ( $V_{CC} = 3.6$  V)

Figure 10.  $Q_C$  vs  $V_{COM}$ 

Figure 11.  $t_{ON}$  and  $t_{OFF}$  vs Supply Voltage

## Typical Characteristics (continued)

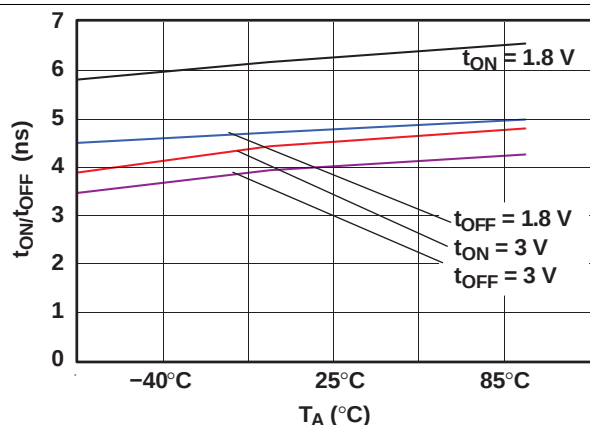


Figure 12.  $t_{ON}$  and  $t_{OFF}$  vs Temperature

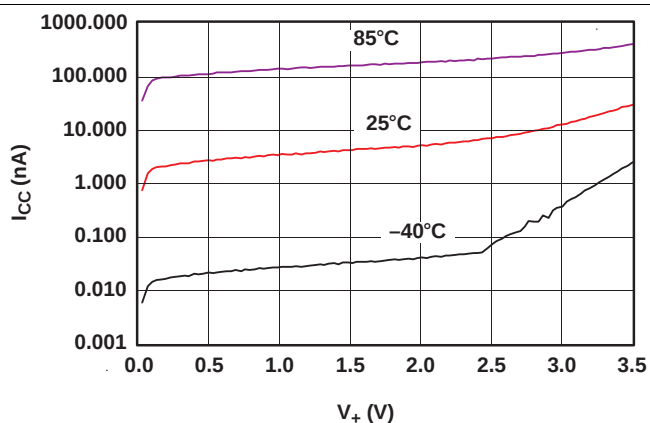


Figure 13.  $I_{CC}$  vs  $V_{CC}$

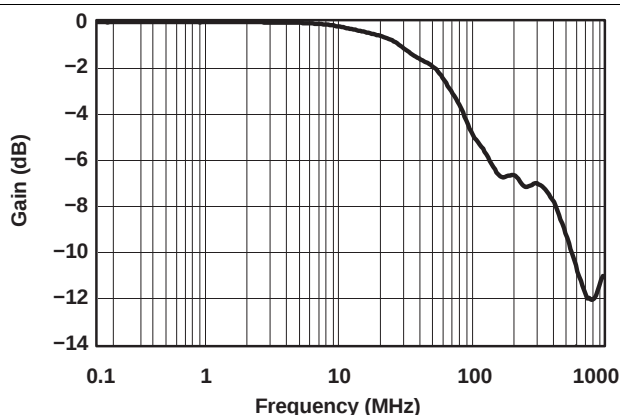


Figure 14. Gain vs Frequency  
( $V_{CC} = 3\text{ V}$ )

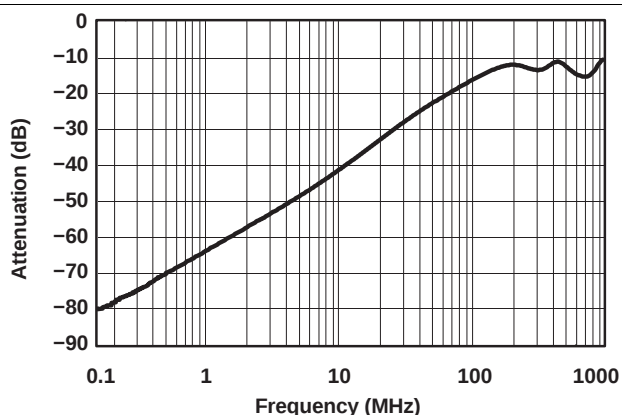


Figure 15. OFF Isolation vs Frequency  
( $V_{CC} = 3\text{ V}$ )

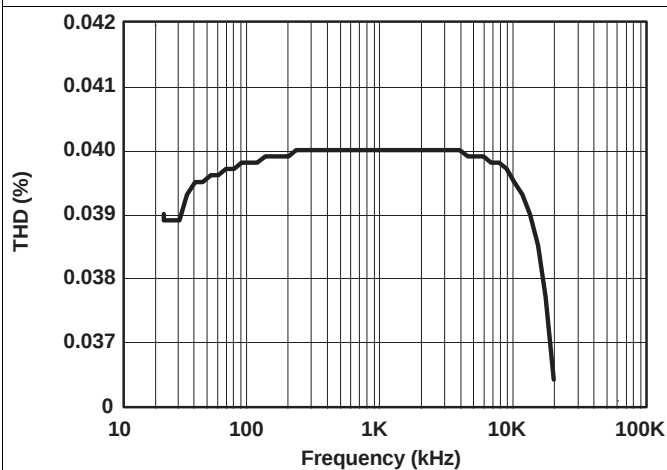


Figure 16. Total Harmonic Distortion vs Frequency  
( $R_L = 32\ \Omega$ )

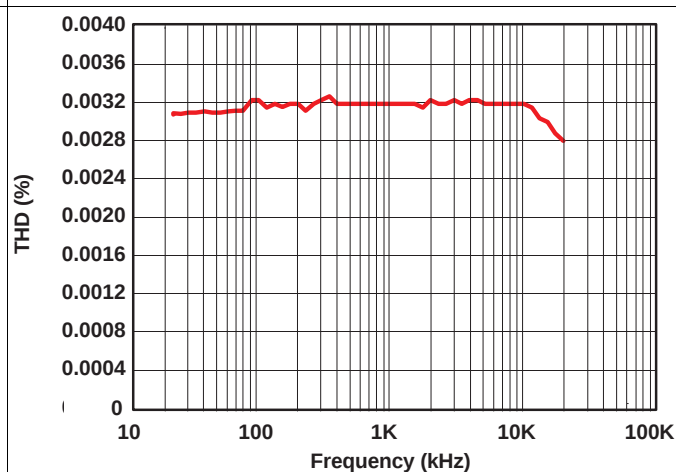


Figure 17. Total Harmonic Distortion vs Frequency  
( $R_L = 600\ \Omega$ )

## Typical Characteristics (continued)

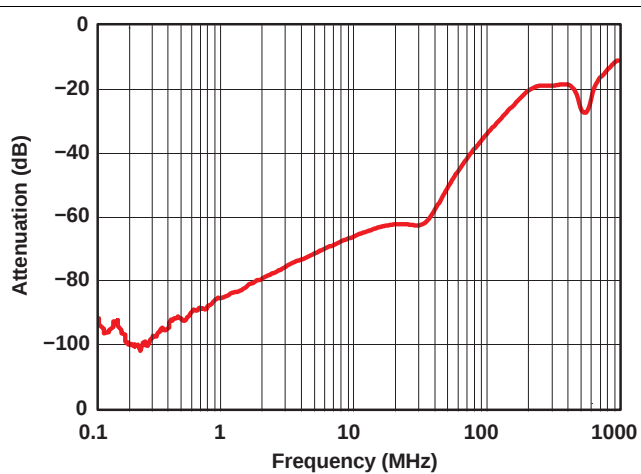


Figure 18. Crosstalk vs Frequency ( $V_{CC} = 3\text{ V}$ )

## 7 Detailed Description

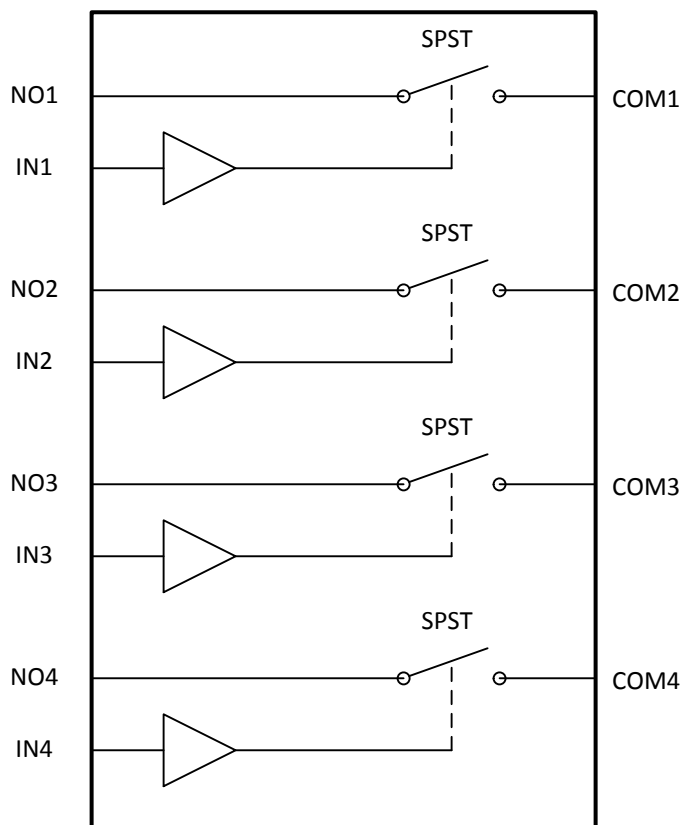
### 7.1 Overview

The TS3A4751 is a bidirectional, 4-channel, normally open (NO) single-pole single-throw (SPST) analog switch that operates from a single 1.6-V to 3.6-V supply. This device has fast switching speeds, handles rail-to-rail analog signals, and consumes very low quiescent power.

The digital input is 1.8-V CMOS compatible when using a 3-V supply.

The TS3A4751 has four normally open (NO) switches. The TS3A4751 is available in a 14-pin thin shrink small-outline package (TSSOP) and in space-saving 14-pin VQFN (RGY) and micro X2QFN (RUC) packages.

### 7.2 Functional Block Diagram



### 7.3 Feature Description

This device has fast switching speeds, handles rail-to-rail analog signals, and consumes very low quiescent power.

The digital input is 1.8-V TTL/CMOS compatible when using a 3-V supply.

### 7.4 Device Functional Modes

**Table 1. Function Table**

| IN | NO TO COM,<br>COM TO NO |
|----|-------------------------|
| L  | OFF                     |
| H  | ON                      |

## 8 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

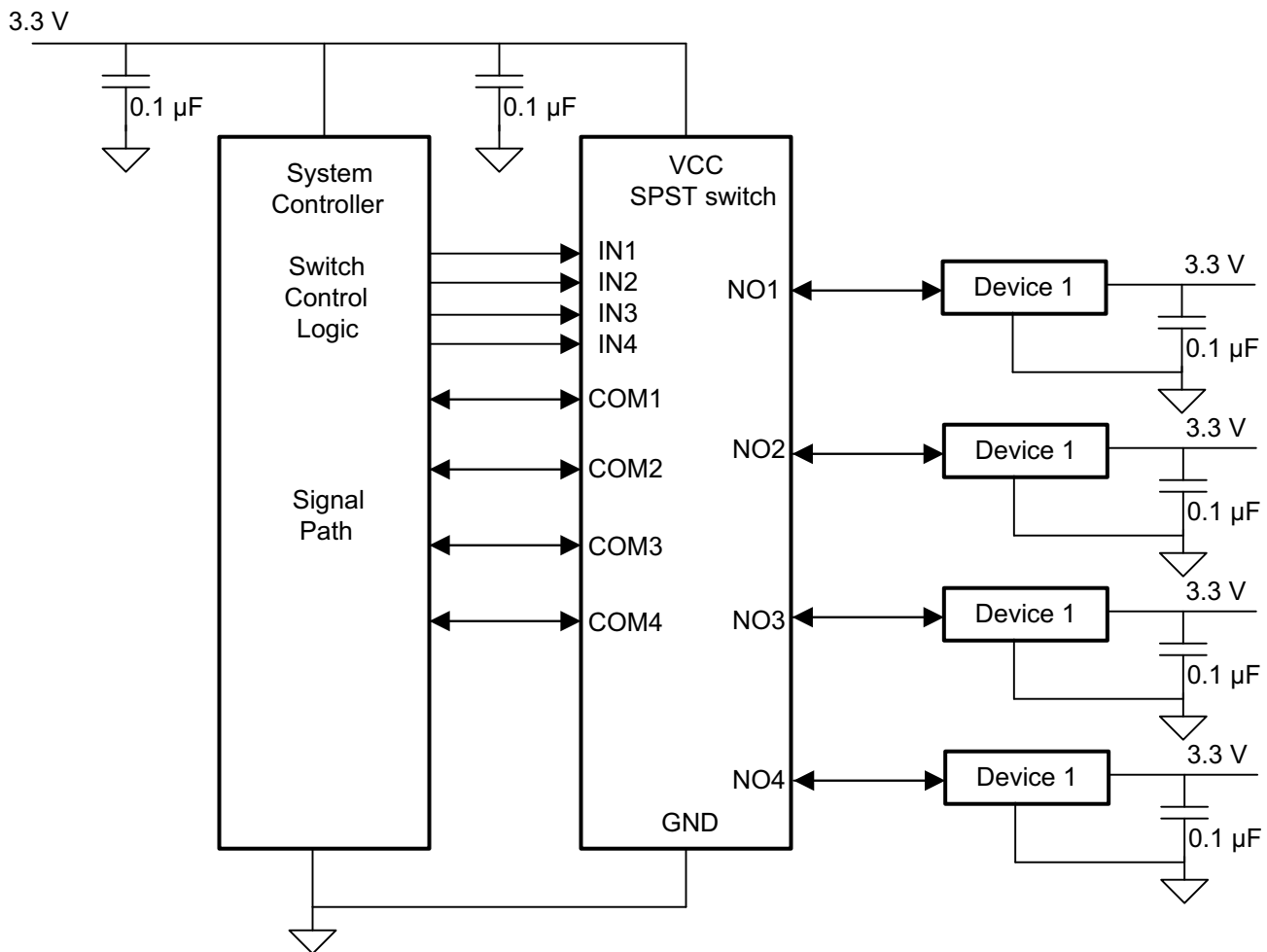
#### 8.1.1 Logic Inputs

The TS3A4751 logic inputs can be driven up to 3.6 V, regardless of the supply voltage. For example, with a 1.8-V supply, IN may be driven low to GND and high to 3.6 V. Driving IN rail to rail minimizes power consumption.

#### 8.1.2 Analog Signal Levels

Analog signals that range over the entire supply voltage ( $V_{CC}$  to GND) can be passed with very little change in  $R_{on}$  (see [Typical Characteristics](#)). The switches are bidirectional, so NO and COM can be used as either inputs or outputs.

### 8.2 Typical Application



**Figure 19. Typical Application Diagram**

## Typical Application (continued)

### 8.2.1 Design Requirements

Ensure that all of the signals passing through the switch are within the specified ranges to ensure proper performance.

### 8.2.2 Detailed Design Procedure

The TS3A4751 can be properly operated without any external components. However, it is recommended that unused pins should be connected to ground through a 50-Ω resistor to prevent signal reflections back into the device. It is also recommended that the digital control pins (INX) be pulled up to  $V_{CC}$  or down to GND to avoid undesired switch positions that could result from the floating pin.

### 8.2.3 Application Curve

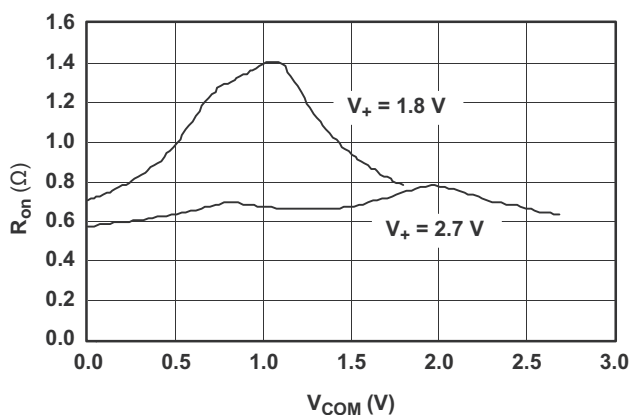


Figure 20.  $R_{on}$  vs  $V_{COM}$

## 9 Power Supply Recommendations

Proper power-supply sequencing is recommended for all CMOS devices. Do not exceed the absolute maximum ratings because stresses beyond the listed ratings can cause permanent damage to the devices. Always sequence  $V_{CC}$  on first, followed by NO or COM.

Although it is not required, power-supply bypassing improves noise margin and prevents switching noise propagation from the  $V_{CC}$  supply to other components. A 0.1- $\mu\text{F}$  capacitor, connected from  $V_{CC}$  to GND, is adequate for most applications.

## 10 Layout

### 10.1 Layout Guidelines

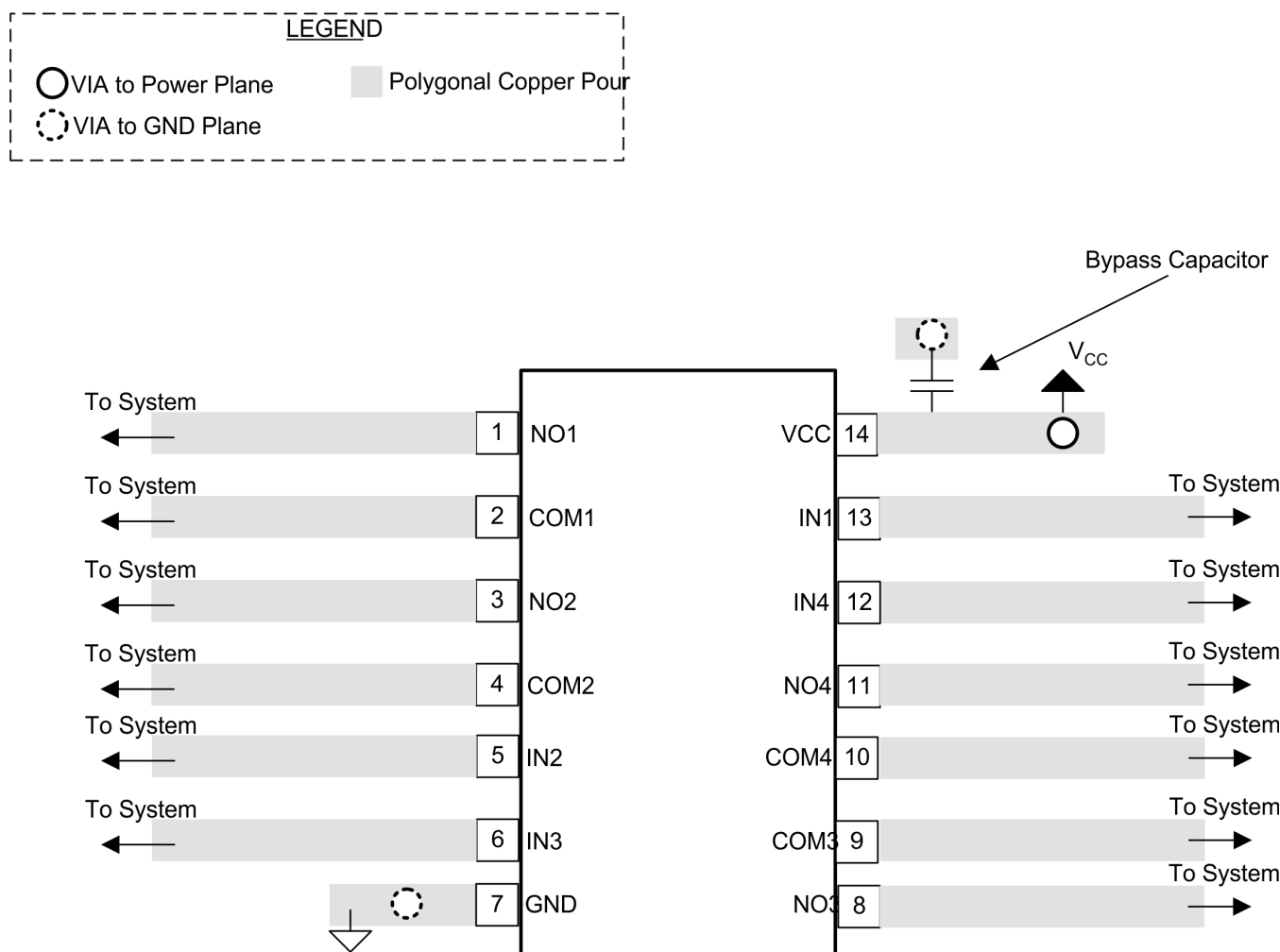
High-speed switches require proper layout and design procedures for optimum performance.

Reduce stray inductance and capacitance by keeping traces short and wide.

Ensure that bypass capacitors are as close to the device as possible.

Use large ground planes where possible.

### 10.2 Layout Example



**Figure 21. Layout Schematic**

## 11 Device and Documentation Support

### 11.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 11.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 11.3 Trademarks

E2E is a trademark of Texas Instruments.  
All other trademarks are the property of their respective owners.

### 11.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 11.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TS3A4751PWR</a>  | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | YC751               |
| TS3A4751PWR.B                | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | YC751               |
| <a href="#">TS3A4751RGYR</a> | Active        | Production           | VQFN (RGY)   14 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | YC751               |
| TS3A4751RGYR.B               | Active        | Production           | VQFN (RGY)   14 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | YC751               |
| TS3A4751RGYRG4               | Active        | Production           | VQFN (RGY)   14 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | YC751               |
| TS3A4751RGYRG4.B             | Active        | Production           | VQFN (RGY)   14 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | YC751               |
| <a href="#">TS3A4751RUCR</a> | Active        | Production           | QFN (RUC)   14  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 3MO                 |
| TS3A4751RUCR.B               | Active        | Production           | QFN (RUC)   14  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 3MO                 |
| TS3A4751RUCRG4.B             | Active        | Production           | QFN (RUC)   14  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 3MO                 |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TS3A4751PWR    | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| TS3A4751RGYR   | VQFN         | RGY             | 14   | 3000 | 330.0              | 12.4               | 3.75    | 3.75    | 1.15    | 8.0     | 12.0   | Q1            |
| TS3A4751RGYRG4 | VQFN         | RGY             | 14   | 3000 | 330.0              | 12.4               | 3.75    | 3.75    | 1.15    | 8.0     | 12.0   | Q1            |
| TS3A4751RUCR   | QFN          | RUC             | 14   | 3000 | 180.0              | 9.5                | 2.2     | 2.2     | 0.5     | 4.0     | 8.0    | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TS3A4751PWR    | TSSOP        | PW              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| TS3A4751RGYR   | VQFN         | RGY             | 14   | 3000 | 353.0       | 353.0      | 32.0        |
| TS3A4751RGYRG4 | VQFN         | RGY             | 14   | 3000 | 353.0       | 353.0      | 32.0        |
| TS3A4751RUCR   | QFN          | RUC             | 14   | 3000 | 189.0       | 185.0      | 36.0        |

## GENERIC PACKAGE VIEW

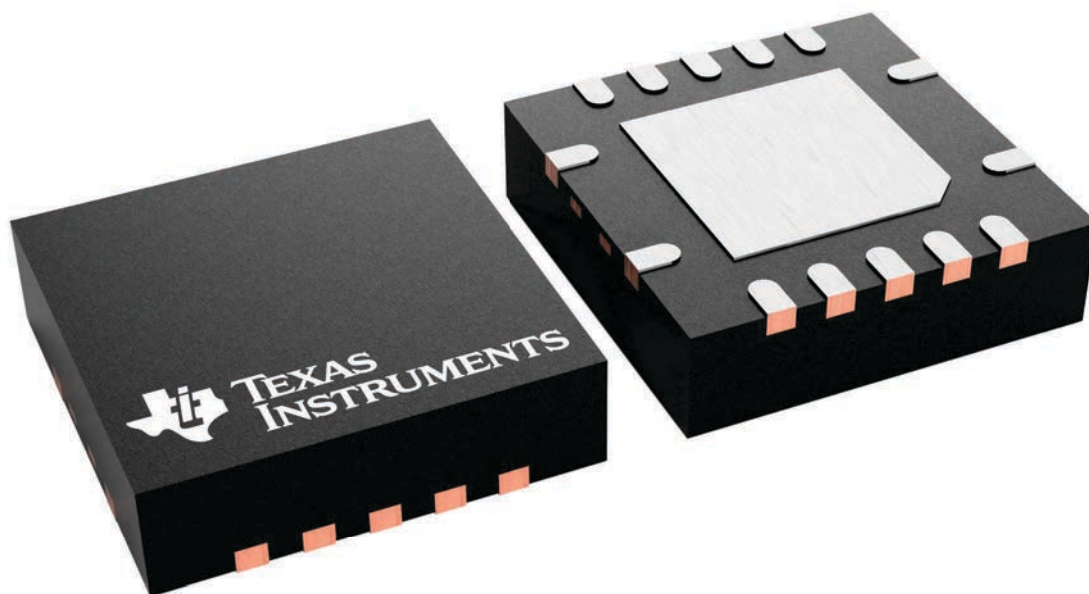
**RGY 14**

**VQFN - 1 mm max height**

3.5 x 3.5, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



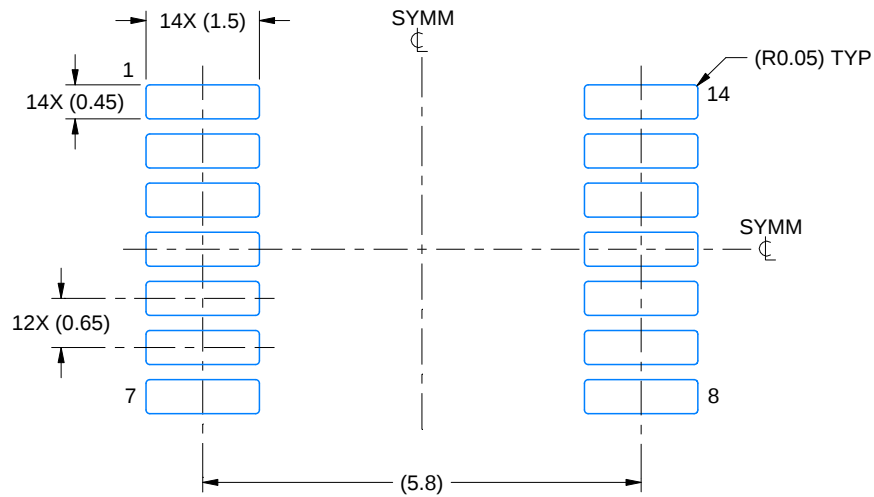


# EXAMPLE BOARD LAYOUT

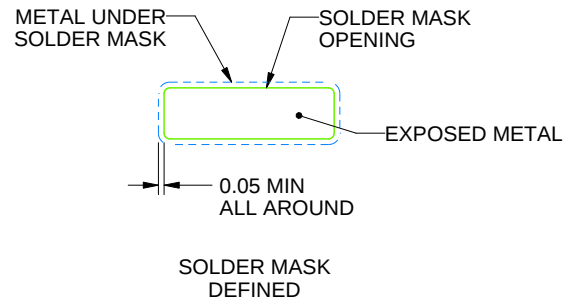
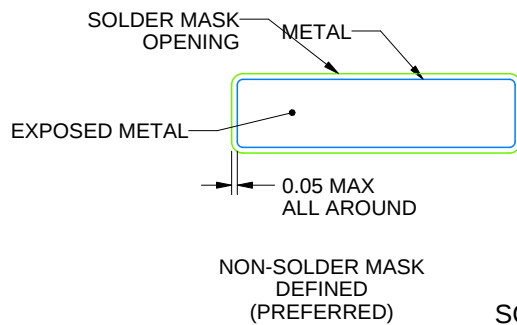
PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4220202/B 12/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

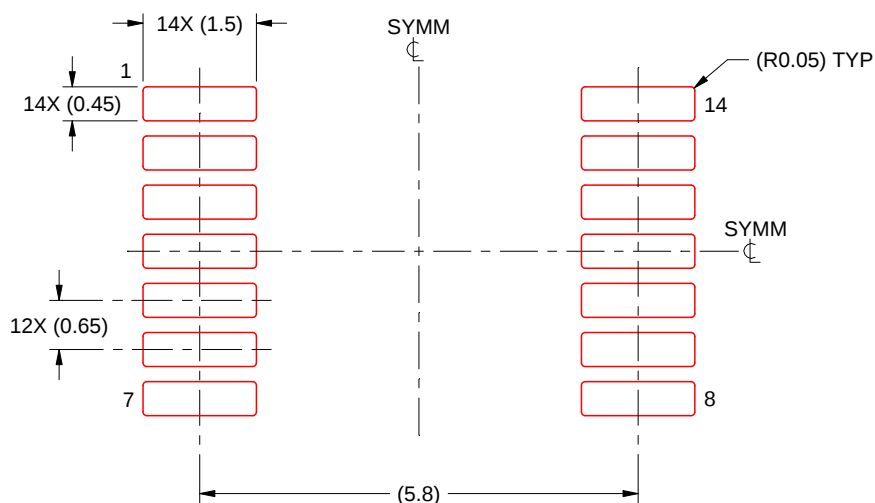
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220202/B 12/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## GENERIC PACKAGE VIEW

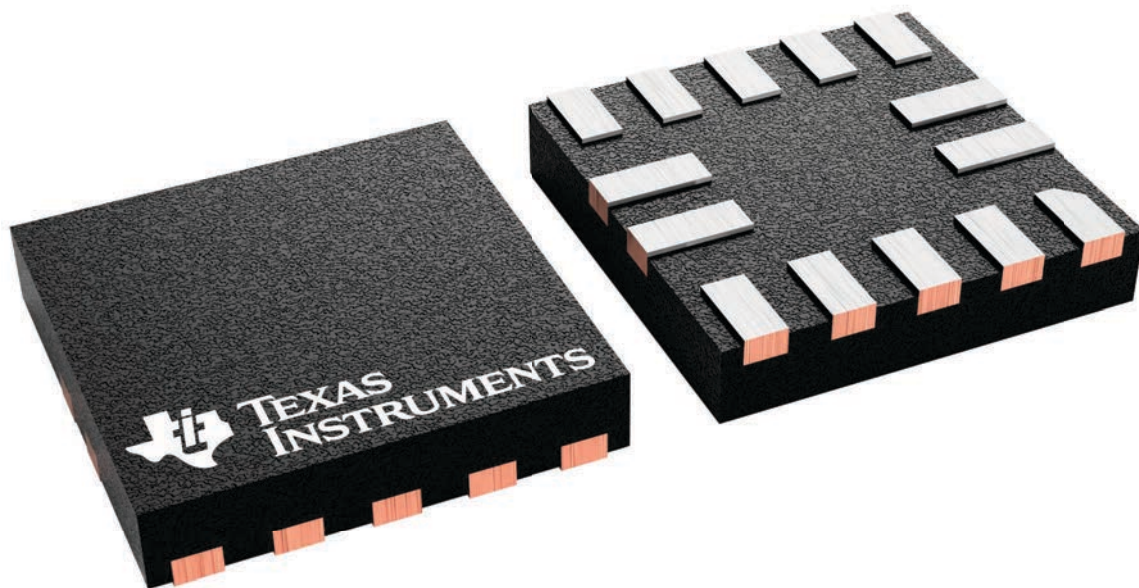
**RUC 14**

**X2QFN - 0.4 mm max height**

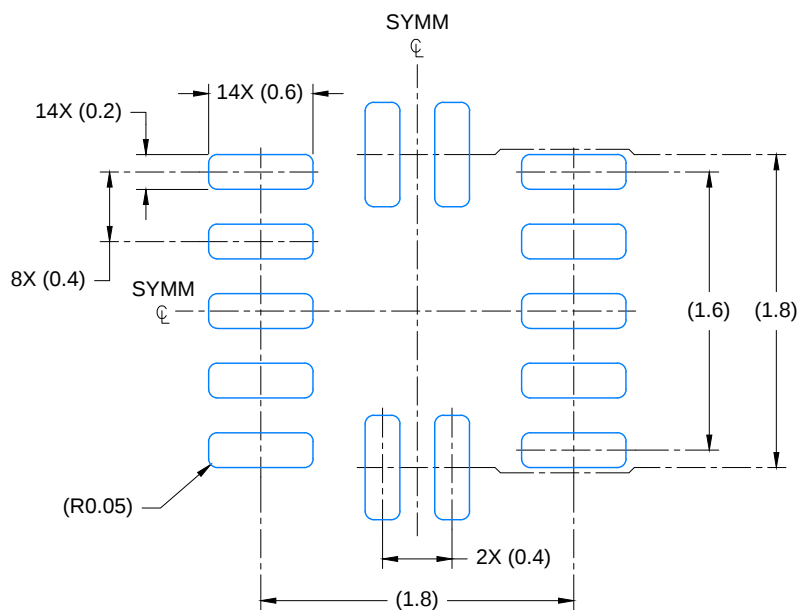
2 x 2, 0.4 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

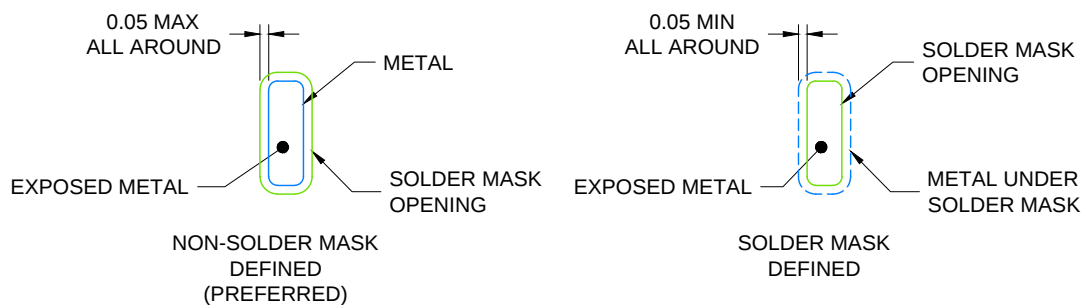
This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.







LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 23X



SOLDER MASK DETAILS

4220584/A 05/2019

NOTES: (continued)

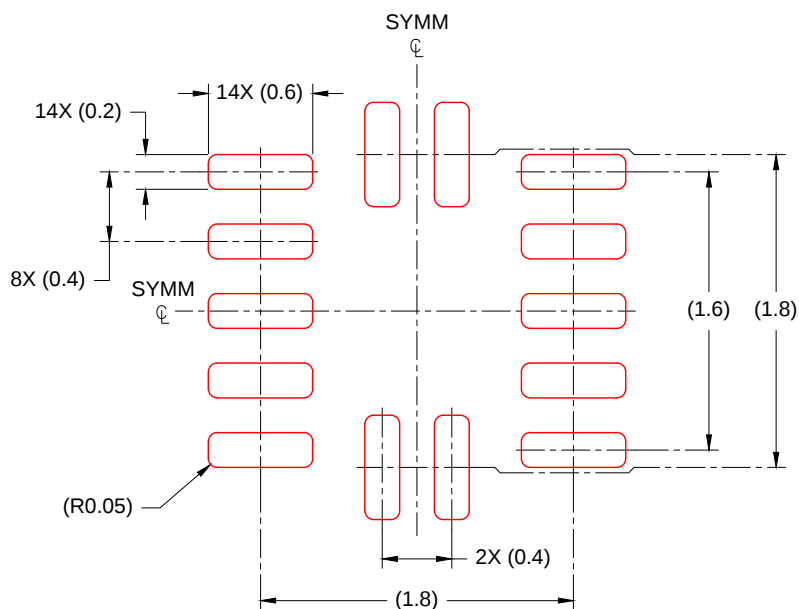
- For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).

## EXAMPLE STENCIL DESIGN

RUC0014A

X2QFN - 0.4 mm max height

PLASTIC QUAD FLAT PACK- NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.100mm THICK STENCIL  
SCALE: 23X

4220584/A 05/2019

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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